

0805 Package Infrared LED with flat top view lens HIR17-21C/L289/TR8



Features

- High reliability
- Small double-end package
- Peak wavelength $\lambda_p=850\text{nm}$
- Package in 8mm tape on 7" diameter reel
- Low forward voltage
- Pb free
- The product itself will remain within RoHS compliant version.
- Compliance with EU REACH
- Compliance Halogen Free .(Br <900 ppm ,Cl <900 ppm , Br+Cl < 1500 ppm).

Descriptions

- HIR17-21C/L289/TR8 is an infrared emitting diode in miniature SMD package which is molded in a water clear plastic with flat top view lens.
- The device is spectrally matched with silicon photodiode and phototransistor.

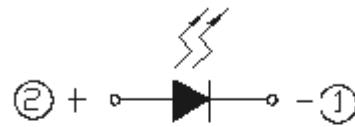
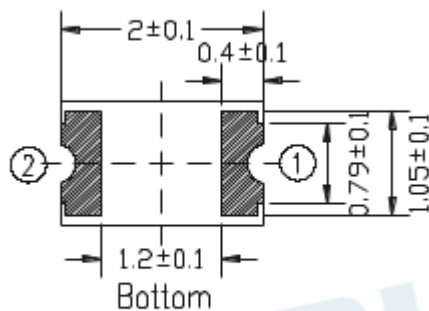
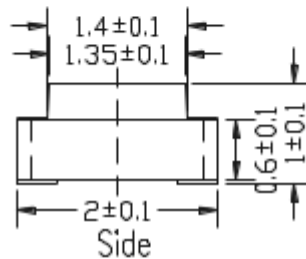
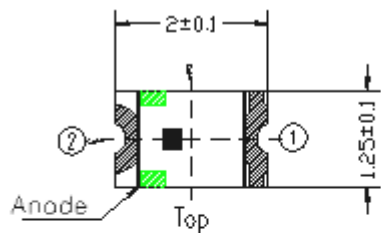
Applications

- PCB mounted infrared sensor
- Infrared remote control units with high power requirement
- Smoke detector
- Infrared applied system

Device Selection Guide

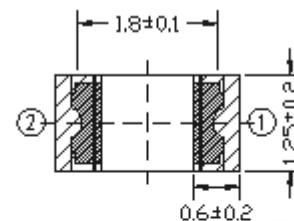
Part Category	Chip Material	Resin Color
HIR17-21C/L289/TR8	AlGaAs	Water Clear

Package Dimensions



① Cathode
② Anode

Recommend Soldering Pad



Suggested pad dimension is just for reference only.
Please modify the pad dimension based on individual need.

- Notes:**
1. All dimensions are in millimeters
 2. Tolerances unless dimensions ± 0.1 mm
 3. Suggested pad dimension is just for reference only
Please modify the pad dimension based on individual need

Absolute Maximum Ratings (Ta=25°C)

Parameter	Symbol	Rating	Unit
Continuous Forward Current	I _F	65	mA
Peak Forward Current *1	I _{FP}	1.0	A
Reverse Voltage	V _R	5	V
Operating Temperature	T _{opr}	-25 ~ +85	°C
Storage Temperature	T _{stg}	-40 ~ +100	°C
Soldering Temperature *2	T _{sol}	260	°C
Power Dissipation at(or below) 25°C Free Air Temperature	P _d	130	mW

Notes:

*1- I_{FP} Conditions: Pulse Width ≤ 100μs and Duty ≤ 1%.

*2- Soldering time ≤ 5 seconds.

Electro-Optical Characteristics (Ta=25°C unless specified otherwise)

Parameter	Symbol	Min.	Typ.	Max.	Unit	Condition
Radiant Intensity	I _e	1.6	2.1	--	mW/sr	I _F =20mA
Peak Wavelength	λ _P	--	850	--	nm	I _F =20mA
Spectral Bandwidth	Δλ	--	30	--	nm	I _F =20mA
Forward Voltage	V _F	1.20	1.40	1.70	V	I _F =20mA
Reverse Current	I _R	--	--	10	μA	V _R =5V
View Angle	2θ _{1/2}	--	140	--	deg	I _F =20mA

Radiant Intensity Specifications for Bin Grading

Condition : I_F=20mA

Unit : mW/sr

Bin Number	A	B	C	D
Min	1.60	1.96	2.35	2.74
Max	2.04	2.45	2.85	3.20

Typical Electro-Optical Characteristics Curves

Fig.1 Forward Current vs.
Ambient Temperature

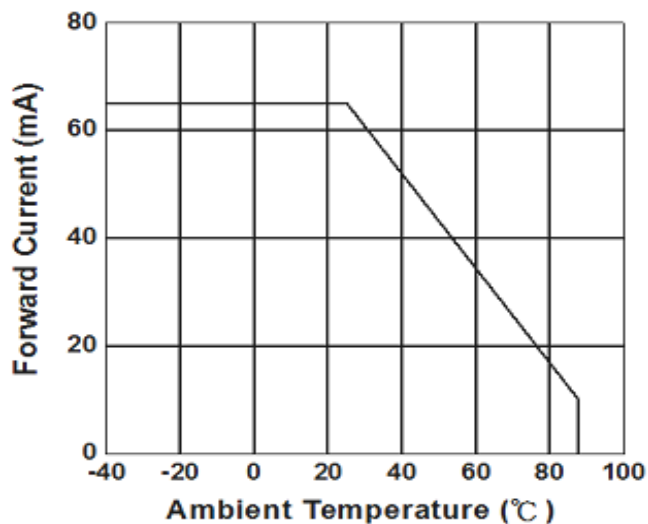


Fig.2 Spectral Distribution
(Test Condition: $I_F=20\text{mA}$)

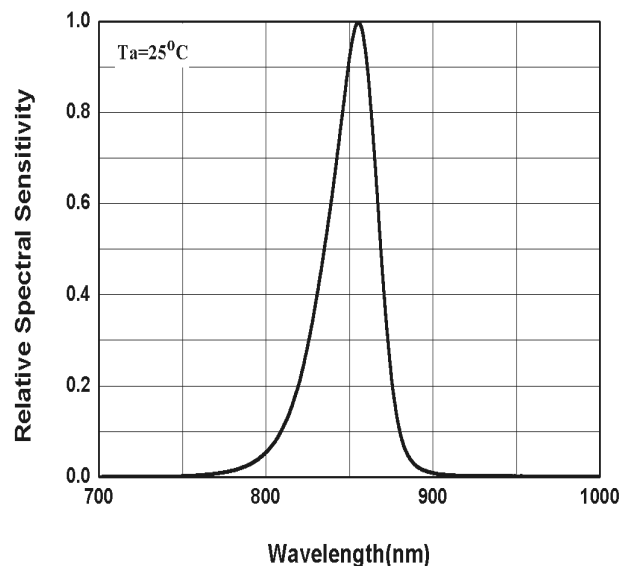


Fig.3 Forward Current
vs. Forward Voltage

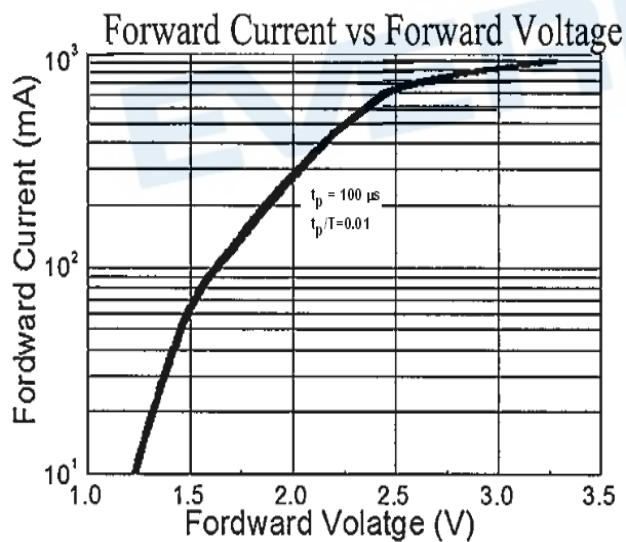
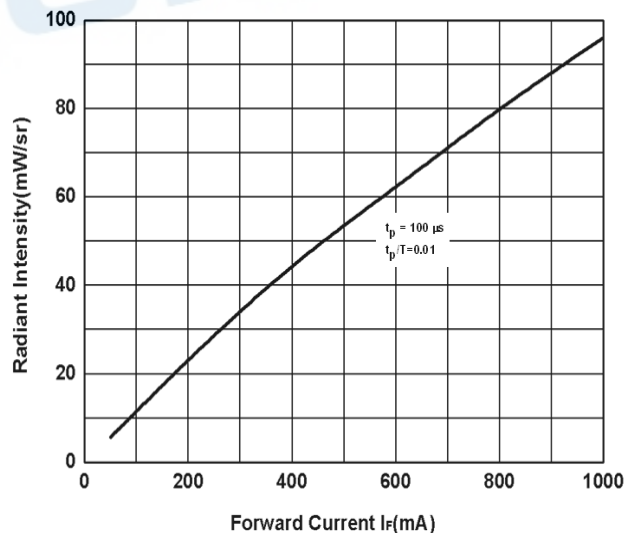
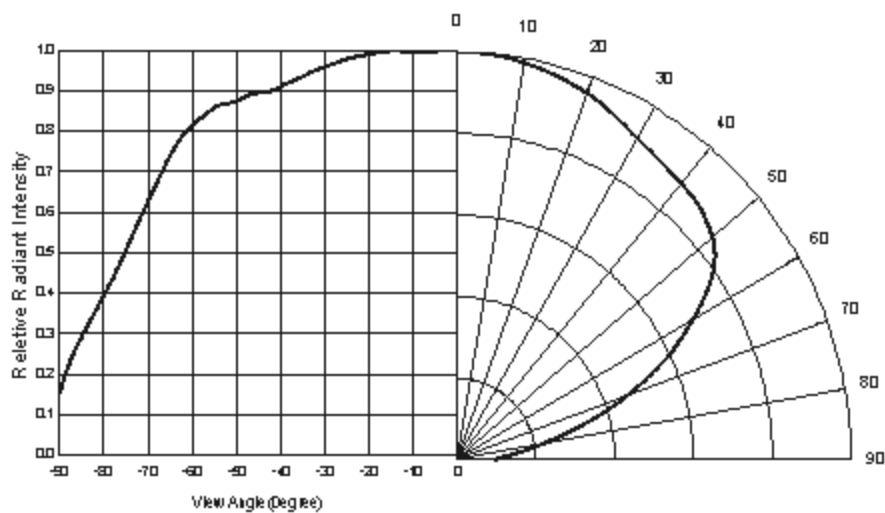


Fig.4 Radiant Intensity vs.
vs. Forward Current



Typical Electro-Optical Characteristics Curves

Fig.5 Relative Radiant Intensity vs.
Angular Displacement (Test Condition: $I_F=20\text{mA}$)



Precautions For Use

1. Over-current-proof

Customer must apply resistors for protection, otherwise slight voltage shift will cause big current change (Burn out will happen).

2. Storage

2.1 Do not open moisture proof bag before the products are ready to use.

2.2 Before opening the package, the LEDs should be kept at 10°C~30°C and 90%RH or less.

2.3 The LEDs suggested be used within one year.

2.4 After opening the package, the devices must be stored at 10°C~30°C and $\leq 60\%RH$, and used within 168 hours (floor life). If unused LEDs remain, it should be stored in moisture proof packages.

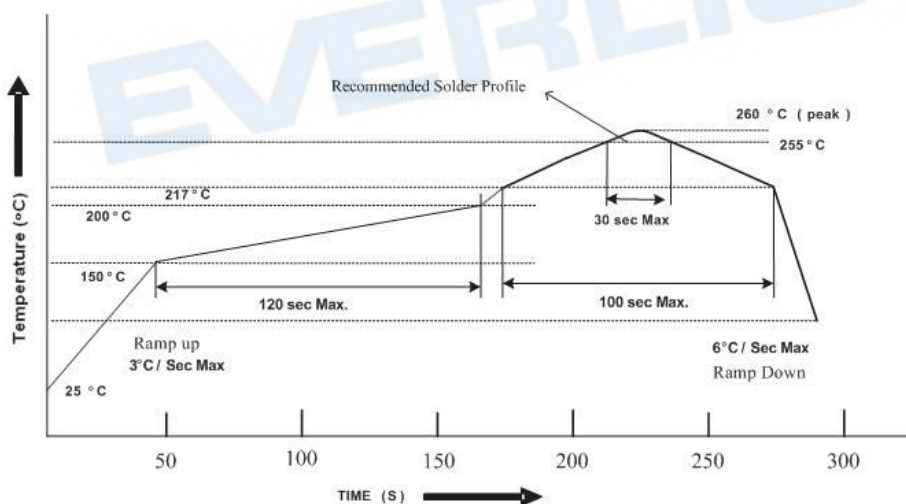
2.5 If the moisture absorbent material (desiccant material) has faded or unopened bag has exceeded the shelf life or devices (out of bag) have exceeded the floor life, baking treatment is required.

2.6 If baking is required, refer to IPC/JEDEC J-STD-033 for bake procedure or recommend the following conditions:

96 hours at 60°C \pm 5°C and < 5 % RH (reeled/tubed/loose units)

3. Soldering Condition

3.1 Pb-free solder temperature profile



3.2 Reflow soldering should not be done more than two times.

3.3 When soldering, do not put stress on the LEDs during heating.

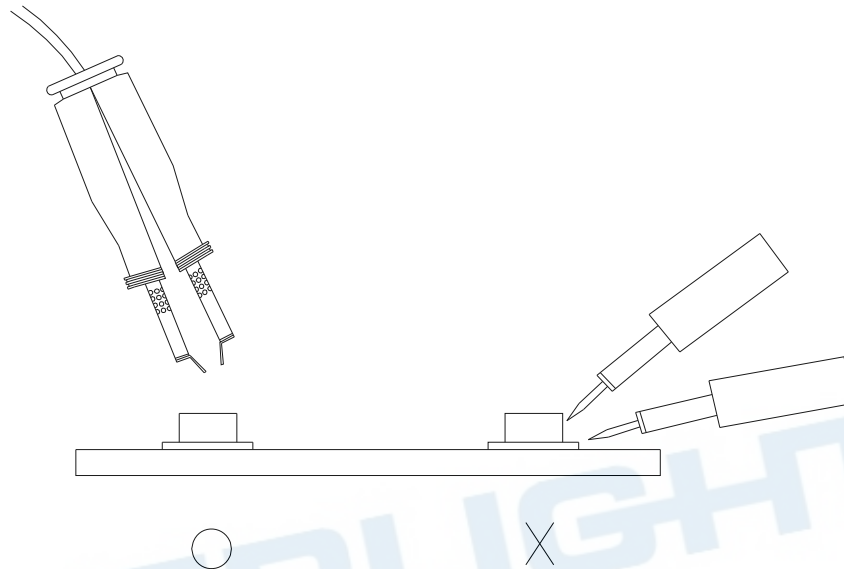
3.4 After soldering, do not warp the circuit board.

4.Soldering Iron

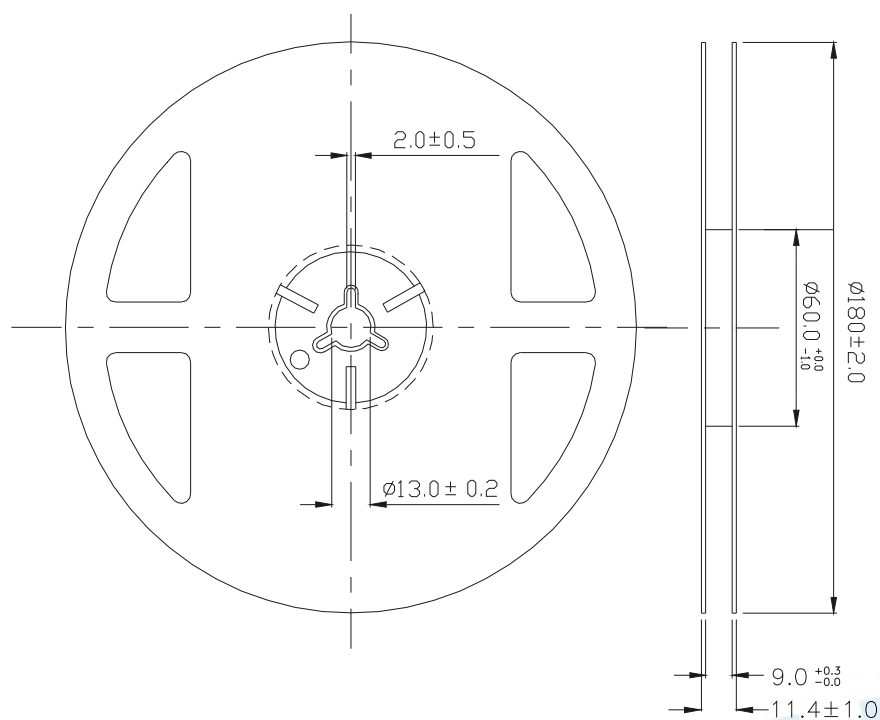
Each terminal is to go to the tip of soldering iron temperature less than 350℃ for 3 seconds within once in less than the soldering iron capacity 25W. Leave two seconds and more intervals, and do soldering of each terminal. Be careful because the damage of the product is often started at the time of the hand solder.

5.Repairing

Repair should not be done after the LEDs have been soldered. When repairing is unavoidable, a double-head soldering iron should be used (as below figure). It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.

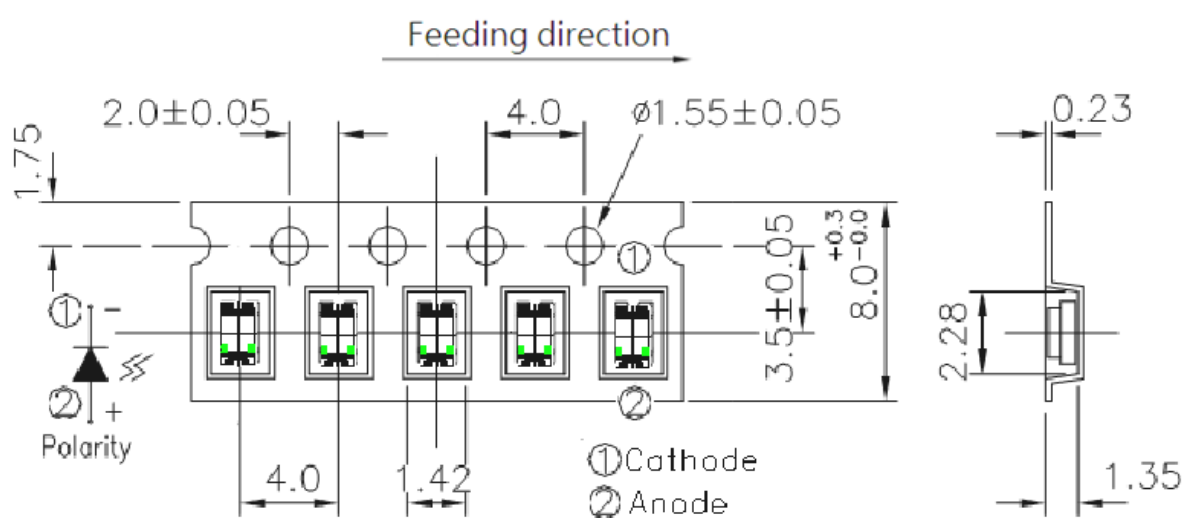


Packing Dimensions











Note: The tolerances unless mentioned is ± 0.1 mm , Unit = mm

Carrier Tape Dimensions: (Quantity: 4000PCS/Reel)



Note: The tolerances unless mentioned is ± 0.1 mm , Unit = mm

Label Form Specification

RoHS		EVERLIGHT	5
CPN: XXXXXXXXXXXXXXXXXXXX			
			
XXXXXXXXXX-XXXXXXXXXX-XXXXXXXXXX-XXXXXXXXXX-XXXXXX			
P/N: XXXXXXXXXXXX			
			
XXXXXXXXXX-XXXXXXXXXX-XXXXXXXXXX-XXXXXXXXXX-XXXXXX			
LOT NO: Y150716XXX-XXXXXXXXXX-XXXXXXXXXX			
			
QTY: 0123456789 HUE: XXXXXXXXXXXX			
			
CAT: XXXXXXXXXXXX REF: XXXXXXXXXXXX			
			
REFERENCE: BTPYMMDDXXXXX			
			
MSL-X MADE IN XXXXXX			
			

CPN: Customer's Production Number

P/N : Production Number

LOT No: Lot Number

QTY: Packing Quantity

HUE: Peak Wavelength

CAT: Ranks

REF: Reference

MSL-X: MSL Level

Made In: Manufacture place

DISCLAIMER

1. EVERLIGHT reserves the right(s) on the adjustment of product material mix for the specification.
2. The product meets EVERLIGHT published specification for a period of twelve (12) months from date of shipment.
3. The graphs shown in this datasheet are representing typical data only and do not show guaranteed values.
4. When using this product, please observe the absolute maximum ratings and the instructions for using outlined in these specification sheets. EVERLIGHT assumes no responsibility for any damage resulting from the use of the product which does not comply with the absolute maximum ratings and the instructions included in these specification sheets.
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